

Absolute Maximum Ratings (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V _{CBO}	-60	V
Collector-Emitter Voltage	V _{CEO}	-60	V
Emitter-Base Voltage	V _{EBO}	-5	V
Collector Current	Ic	-600	mA

Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 6)	P_{D}	200	mW
Thermal Resistance, Junction to Ambient (Note 6)	$R_{\theta JA}$	625	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

ESD Ratings (Note 7)

Characteristic	Symbol	Value	Unit	JEDEC Class
Electrostatic Discharge - Human Body Model	ESD HBM	4,000	V	3A
Electrostatic Discharge - Machine Model	ESD MM	400	V	С

Notes:

- 6. For a device mounted with the collector lead on minimum recommended pad layout 1oz copper that is on a single-sided 1.6mm FR4 PCB; device is measured under still air conditions whilst operating in a steady-state.
- 7. Refer to JEDEC specification JESD22-A114 and JESD22-A115.

Thermal Characteristics and Derating Information

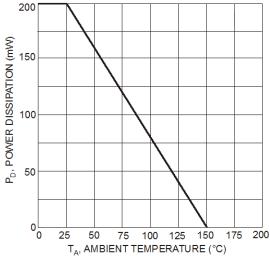


Fig. 1 Max Power Dissipation vs. Ambient Temperature



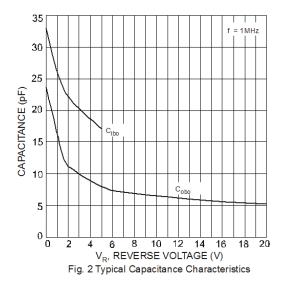
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

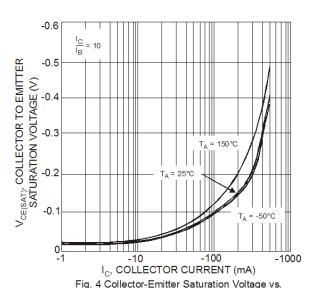
Characteristic	Symbol	Min	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 8)						
Collector-Base Breakdown Voltage	BV _{CBO}	-60	_	V	$I_{C} = -10\mu A, I_{E} = 0$	
Collector-Emitter Breakdown Voltage	BV _{CEO}	-60		V	$I_{C} = -10 \text{mA}, I_{B} = 0$	
Emitter-Base Breakdown Voltage	BV _{EBO}	-5		V	$I_E = -10\mu A, I_C = 0$	
Collector Base Cutoff Current	I _{CBO}		-10	nΑ μΑ	$V_{CB} = -50V, I_E = 0$ $V_{CB} = -50V, I_E = 0, T_A = +125$ °C	
Collector Cutoff Current	I _{CEX}	_	-50	nA	$V_{CE} = -30V, V_{EB(OFF)} = -0.5V$	
Base Cutoff Current	I _{BL}	_	-50	nA	$V_{CE} = -30V, V_{EB(OFF)} = -0.5V$	
ON CHARACTERISTICS (Note 8)						
DC Current Gain	h _{FE}	75 100 100 100 50	 300 	_	$I_{C} = -100\mu A, V_{CE} = -10V$ $I_{C} = -1mA, V_{CE} = -10V$ $I_{C} = -10mA, V_{CE} = -10V$ $I_{C} = -150mA, V_{CE} = -10V$ $I_{C} = -500mA, V_{CE} = -10V$	
Collector-Emitter Saturation Voltage	V _{CE(SAT)}	_	-0.4 -1.6	V	$I_C = -150 \text{mA}, I_B = -15 \text{mA}$ $I_C = -500 \text{mA}, I_B = -50 \text{mA}$	
Base-Emitter Saturation Voltage	V _{BE(SAT)}		1.3 2.6	V	$I_C = -150$ mA, $I_B = -15$ mA $I_C = -500$ mA, $I_B = -50$ mA	
SMALL SIGNAL CHARACTERISTICS						
Output Capacitance	C _{OBO}		8	pF	$V_{CB} = -10V$, $f = 1.0MHz$, $I_E = 0$	
Input Capacitance	C _{IBO}		30	pF	$V_{EB} = -2V$, $f = 1.0MHz$, $I_{C} = 0$	
Current Gain-Bandwidth Product	f⊤	200		MHz	$V_{CE} = -20V, I_{C} = -50mA,$ f = 100MHz	
SWITCHING CHARACTERISTICS						
Turn-On Time	t _{ON}	_	45	ns	V _{CC} = -30V, I _C = -150mA,	
Delay Time	t _D	_	10	ns	$I_{B1} = -15 \text{mA}$	
Rise Time	t _R	_	40	ns	IB1 — - IOIIIA	
Turn-Off Time	t _{OFF}		100	ns	$V_{CC} = -6V$, $I_{C} = -150$ mA,	
Storage Time	t _S		80	ns	$V_{CC} = -6V, I_C = -150 \text{ mA},$ $I_{B1} = I_{B2} = -15 \text{ mA}$	
Fall Time	t _F	_	30	ns	1B1 = 1B2 = - 10111A	

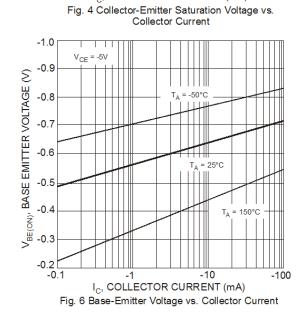
Note: 8. Measured under pulsed conditions. Pulse width \leq 300 μ s. Duty cycle \leq 2%.



Typical Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)







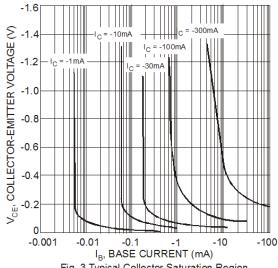
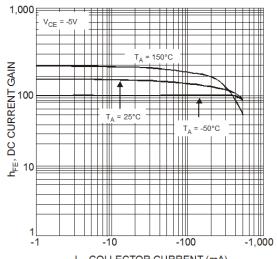


Fig. 3 Typical Collector Saturation Region



 I_C , COLLECTOR CURRENT (mA) Fig. 5 DC Current Gain vs. Collector Current

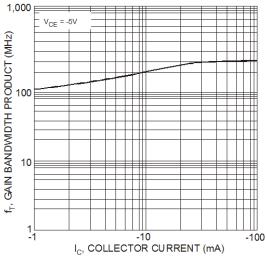


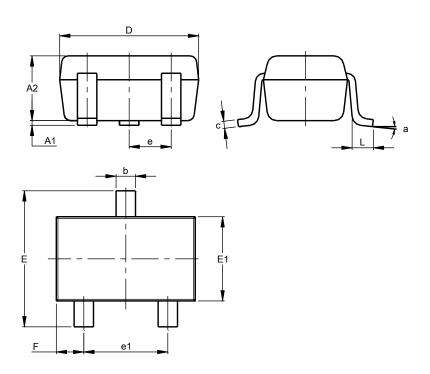
Fig. 7 Gain Bandwidth Product vs. Collector Current



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT323

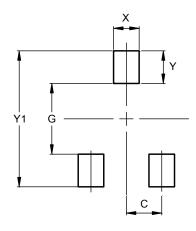


SOT323					
Dim	Min	Max	Тур		
A1	0.00	0.10	0.05		
A2	0.90	1.00	0.95		
b	0.25	0.40	0.30		
C	0.10	0.18	0.11		
D	1.80	2.20	2.15		
Е	2.00	2.20	2.10		
E1	1.15	1.35	1.30		
е	0.650 BSC				
e1	1.20	1.40	1.30		
F	0.375	0.475	0.425		
L	0.25	0.40	0.30		
а	0°	8°	ı		
All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT323



Dimensions	Value (in mm)		
С	0.650		
G	1.300		
Х	0.470		
Y	0.600		
Y1	2.500		



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